

# Multi-Phase PWM Controller for CPU Core Power Supply

## General Description

The RT9246A is a multi-phase buck DC/DC controller integrated with all control functions for GHz CPU VRM. The RT9246A controls 2 or 3 buck switching stages operating in interleaved phase set automatically. The multi-phase architecture provides high output current while maintaining low power dissipation on power devices and low stress on input and output capacitors. The high equivalent operating frequency also reduces the component dimension and the output voltage ripple in load transient.

RT9246A controls both voltage and current loops to achieve good regulation, response & power stage thermal balance. Precise current loop using Inductor DCR as sense component builds precise load line for strict VRM DC & transient specification and also ensures thermal balance of different power stages. The settings of current sense, droop tuning,  $V_{CORE}$  initial offset and over current protection are independent to compensation circuit of voltage loop. The feature greatly facilitates the flexibility of CPU power supply design and tuning.

The DAC output of RT9246A supports K8 CPU by 5-bit VID input, precise initial value & smooth  $V_{CORE}$  transient at VID jump. The IC monitors the  $V_{CORE}$  voltage for PGOOD and over-voltage protection. Soft-start, over-current protection and programmable under-voltage lockout are also provided to assure the safety of microprocessor and power system.

## Ordering Information

RT9246A □ □

- Package Type  
C : TSSOP-28
- Operating Temperature Range  
P : Pb Free with Commercial Standard  
G : Green (Halogen Free with Commercial Standard)

Note :

RichTek Pb-free and Green products are :

- ▶RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶Suitable for use in SnPb or Pb-free soldering processes.
- ▶100% matte tin (Sn) plating.

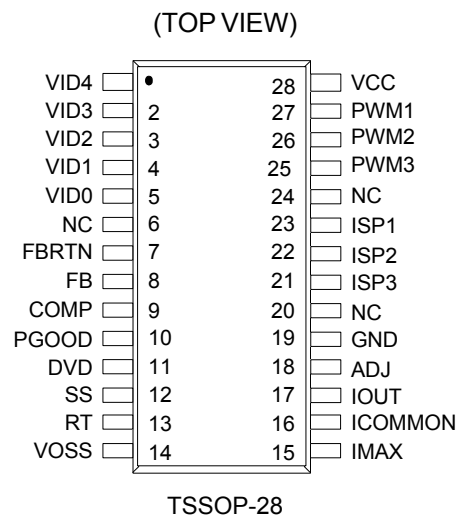
## Features

- Multi-Phase Power Conversion with Automatic Phase Selection
- K8 DAC Output with Active Droop Compensation for Fast Load Transient
- Smooth  $V_{CORE}$  Transition at VID Jump
- Power Stage Thermal Balance by Inductor DCR Current Sense
- Hiccup Mode Over-Current Protection
- Programmable Switching Frequency (50kHz to 400kHz per Phase), Under-Voltage Lockout and Soft-Start
- High Ripple Frequency Times Channel Number
- RoHS Compliant and 100% Lead (Pb)-Free

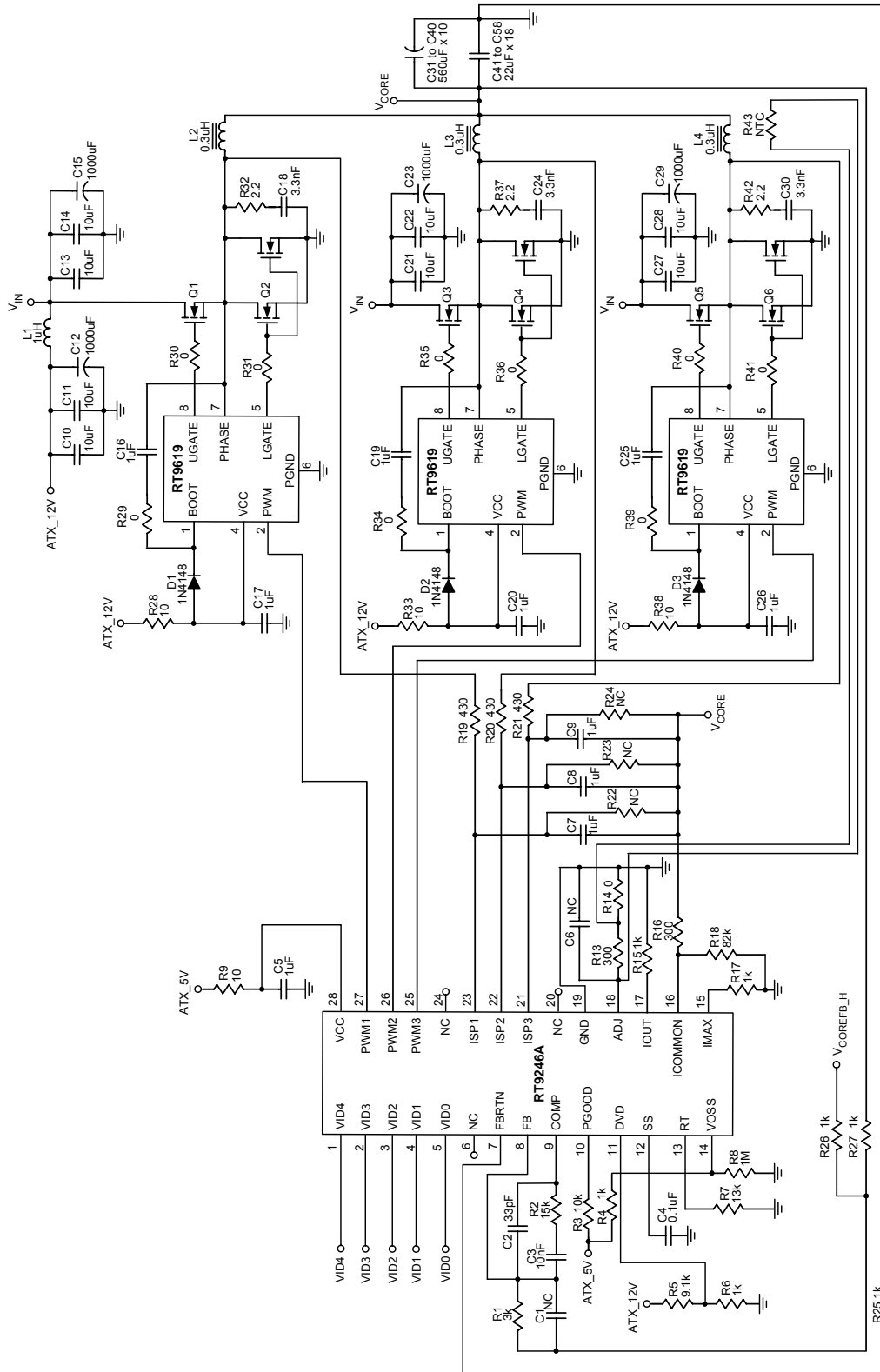
## Applications

- AMD® Athlon™ 64 and Opteron™ Processors Voltage Regulator
- Low Output Voltage, High Current DC-DC Converters
- Voltage Regulator Modules

## Pin Configurations



## Typical Application Circuit



**Functional Pin Description**

**VID4 (Pin 1), VID3 (Pin 2), VID2 (Pin 3), VID1 (Pin 4), VID0 (Pin 5)**

DAC voltage identification inputs for K8. These pins are internally pulled to 2.2V if left open.

**NC (Pin 6, Pin 20, Pin 24)**

No Input Connection

**FBRTN (Pin 7)**

V<sub>CORE</sub> differential sense return.

**FB (Pin 8)**

Inverting input of the internal error amplifier.

**COMP (Pin 9)**

Output of the error amplifier and input of the PWM comparator.

**PGOOD (Pin 10)**

Power good open-drain output.

**DVD (Pin 11)**

Programmable power UVLO detection or converter enable input.

**SS (Pin 12)**

Connect this SS pin to GND with a capacitor to set the soft-start time interval and to smooth V<sub>CORE</sub> transient at VID Jump.

**RT (Pin 13)**

Switching frequency setting. Connect this pin to GND with a resistor to set the frequency.

**VOSS (Pin 14)**

V<sub>CORE</sub> initial value offset. Connect this pin to GND with a resistor to set the offset value.

**IMAX (Pin 15)**

Over-Current protection set.

**ICOMMON (Pin 16)**

Common negative input of current sense amplifiers for all three channels.

**IOUT (Pin 17)**

Output current indication pin. The current through IOUT pin is proportional to the output current.

**ADJ (Pin 18)**

Current sense output for active droop adjust. Connect a resistor from this pin to GND to set the load droop.

**GND (Pin 19)**

IC ground.

**ISP1 (Pin 23), ISP2 (Pin 22), ISP3 (Pin 21)**

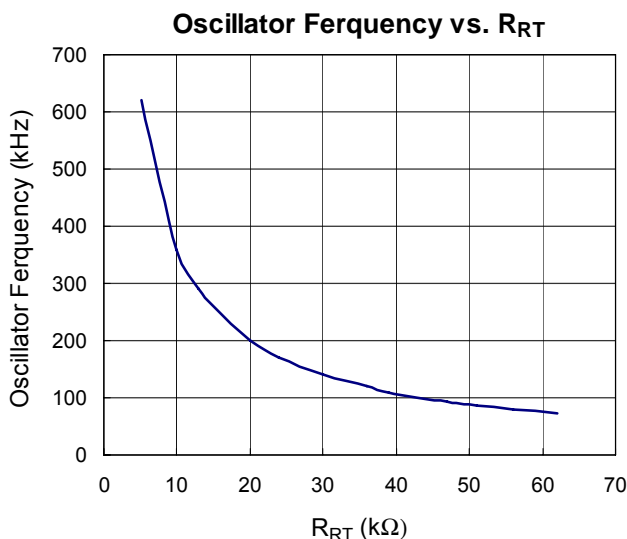
Current sense positive input pins for individual converter channel current sensing.

**PWM1 (Pin 27), PWM2 (Pin 26), PWM3 (Pin 25)**

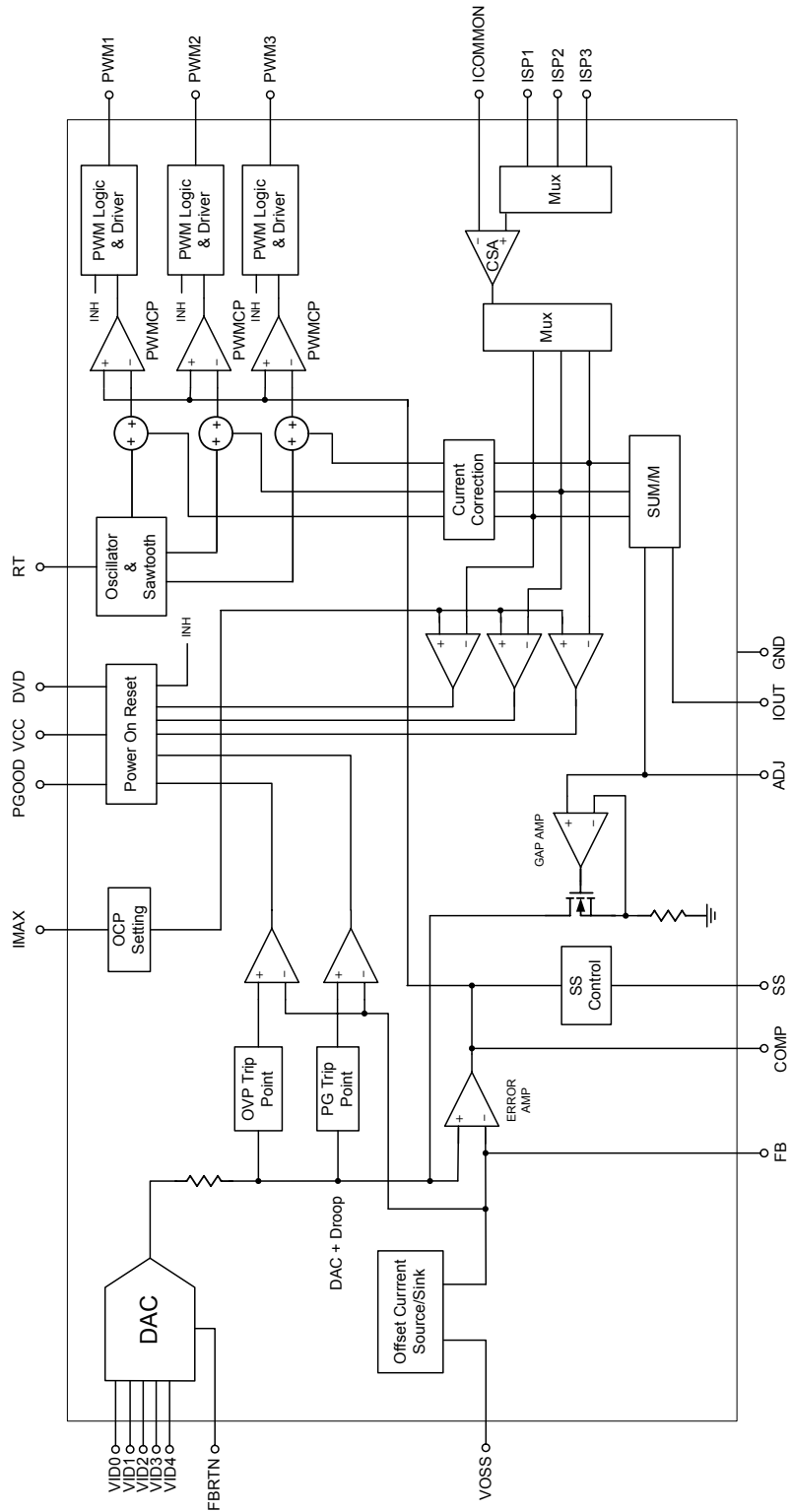
PWM outputs for each driven channel. Connect these pins to the PWM input of the MOSFET driver. For systems which use 2 channels, connect PWM3 high.

**VCC (Pin 28)**

IC power supply. Connect this pin to a 5V supply.



## Function Block Diagram



**Table 1. Output Voltage Program**

VID4	VID3	VID2	VID1	VID0	Nominal Output Voltage DACOUT
0	0	0	0	0	1.550
0	0	0	0	1	1.525
0	0	0	1	0	1.500
0	0	0	1	1	1.475
0	0	1	0	0	1.450
0	0	1	0	1	1.425
0	0	1	1	0	1.400
0	0	1	1	1	1.375
0	1	0	0	0	1.350
0	1	0	0	1	1.325
0	1	0	1	0	1.200
0	1	0	1	1	1.275
0	1	1	0	0	1.250
0	1	1	0	1	1.225
0	1	1	1	0	1.200
0	1	1	1	1	1.175
1	0	0	0	0	1.150
1	0	0	0	1	1.125
1	0	0	1	0	1.100
1	0	0	1	1	1.075
1	0	1	0	0	1.050
1	0	1	0	1	1.025
1	0	1	1	0	1.000
1	0	1	1	1	0.975
1	1	0	0	0	0.950
1	1	0	0	1	0.925
1	1	0	1	0	0.900
1	1	0	1	1	0.875
1	1	1	0	0	0.850
1	1	1	0	1	0.825
1	1	1	1	0	0.800
1	1	1	1	1	Shutdown

Note: (1) 0 : Connected to GND  
 (2) 1 : Open

## Absolute Maximum Ratings (Note 1)

- Supply Voltage,  $V_{CC}$  ----- 7V
- Input, Output or I/O Voltage ----- GND-0.3V to  $V_{CC}+0.3V$
- Power Dissipation,  $P_D @ T_A = 25^\circ C$   
 TSSOP-28 ----- 1W
- Package Thermal Resistance (Note 4)  
 TSSOP-28,  $\theta_{JA}$  ----- 100°C/W
- Junction Temperature ----- 150°C
- Lead Temperature (Soldering, 10 sec.) ----- 260°C
- Storage Temperature Range ----- -65°C to 150°C
- ESD Susceptibility (Note 2)  
 HBM (Human Body Mode) ----- 2kV  
 MM (Machine Mode) ----- 200V

## Recommended Operating Conditions (Note 3)

- Supply Voltage,  $V_{CC}$  ----- 5V  $\pm$  10%
- Ambient Temperature Range ----- 0°C to 70°C
- Junction Temperature Range ----- 0°C to 125°C

## Electrical Characteristics

( $V_{CC} = 5V, T_A = 25^\circ C$ , unless otherwise specified)

Parameter		Symbol	Test Conditions	Min	Typ	Max	Units
<b>V<sub>CC</sub> Supply Current</b>							
Nominal Supply Current		$I_{CC}$	PWM 1,2,3 Open	--	12	--	mA
<b>Power-On Reset</b>							
POR Threshold		$V_{CCRTH}$	$V_{CC}$ Rising	4.0	4.2	4.5	V
Hysteresis		$V_{CCCHYS}$		0.2	0.5	--	V
$V_{DVID}$ Threshold	Input High	$V_{DVIDTH}$	Enable	0.9	1.0	1.1	V
	Input Low	$V_{DVIDHYS}$		--	60	--	mV
<b>Oscillator</b>							
Free Running Frequency		$f_{OSC}$	$R_{RT} = 20k\Omega$	170	200	230	kHz
Frequency Adjustable Range		$f_{OSC\_ADJ}$		50	--	400	kHz
Ramp Amplitude		$\Delta V_{OSC}$	$R_{RT} = 20k\Omega$	--	1.9	--	V
Ramp Valley		$V_{RV}$		--	1.0	--	V
Maximum On-Time of Each Channel				62	66	75	%
RT Pin Voltage		$V_{RT}$	$R_{RT} = 20k\Omega$	0.9	1.0	1.1	V
<b>Reference and DAC</b>							
DACOUT Voltage Accuracy		$\Delta V_{DAC}$	$V_{DAC} \geq 1V$	-1	--	+1	%
			$V_{DAC} < 1V$	-10	--	+10	mV
DAC (VID0-VID4) Input Low		$\Delta V_{ILDAC}$		--	--	0.8	V
DAC (VID0-VID4) Input High		$\Delta V_{IHDAC}$		1.2	--	--	V

*To be continued*

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
DAC (VID0-VID4) Pull-up Voltage			2.0	2.2	2.4	V
DAC (VID0-VID4) Pull-up Resistance			10	13	16	kΩ
VOSS Pin Voltage	V <sub>VOSS</sub>	R <sub>VOSS</sub> = 100kΩ	0.9	1.0	1.1	V
<b>Error Amplifier</b>						
DC Gain			--	65	--	dB
Gain-Bandwidth Product	GBW		--	10	--	MHz
Slew Rate	SR	C <sub>COMP</sub> = 10pF	--	8	--	V/μs
<b>Current Sense GM Amplifier</b>						
ICOMMON Full Scale Source Current			100	--	--	μA
ICOMMON Current for OCP			150	--	--	μA
<b>Protection</b>						
IMAX Voltage	V <sub>IMAX</sub>	R <sub>IMAX</sub> = 10k	0.84	0.94	1.05	V
Over-Voltage Trip (V <sub>FB</sub> - V <sub>DAC</sub> )	Δ <sub>OVT</sub>	R <sub>ADJ</sub> = 0	340	400	450	mV
<b>Power Good</b>						
Output Low Voltage	V <sub>PGOODL</sub>	I <sub>PGOOD</sub> = 4mA	--	--	0.2	V

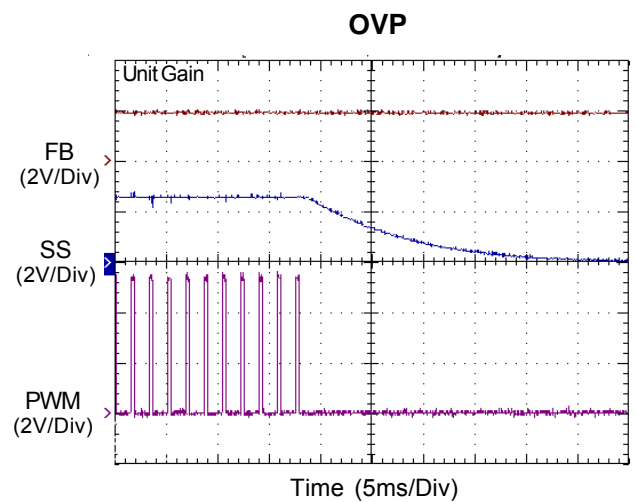
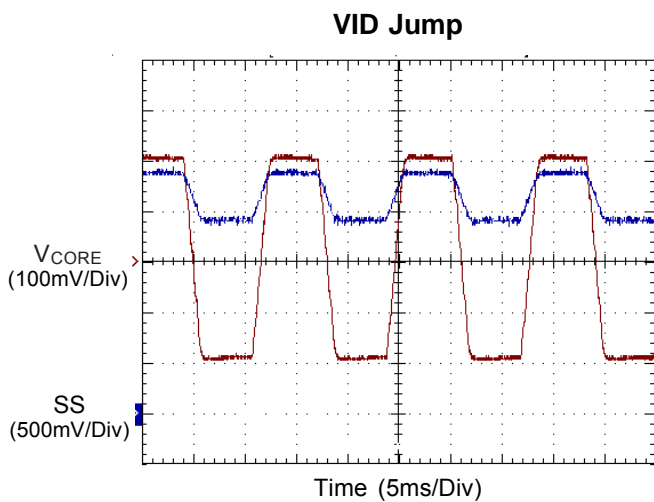
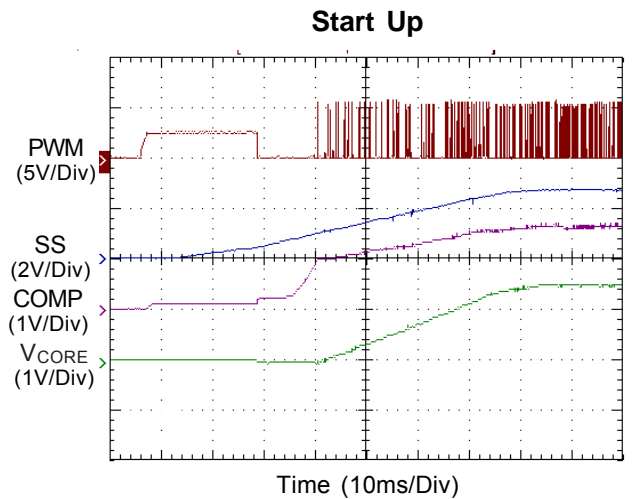
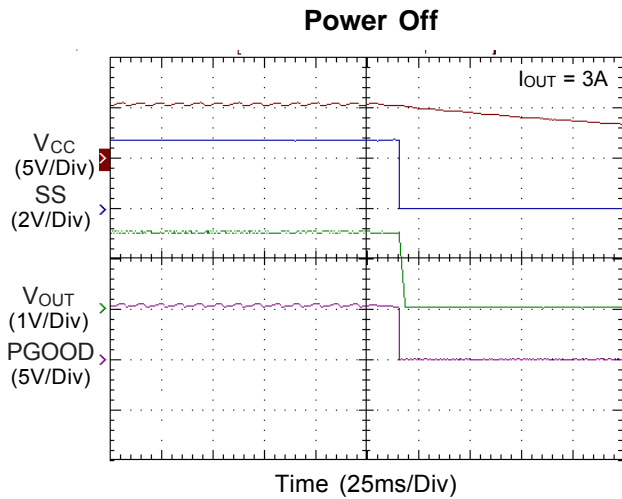
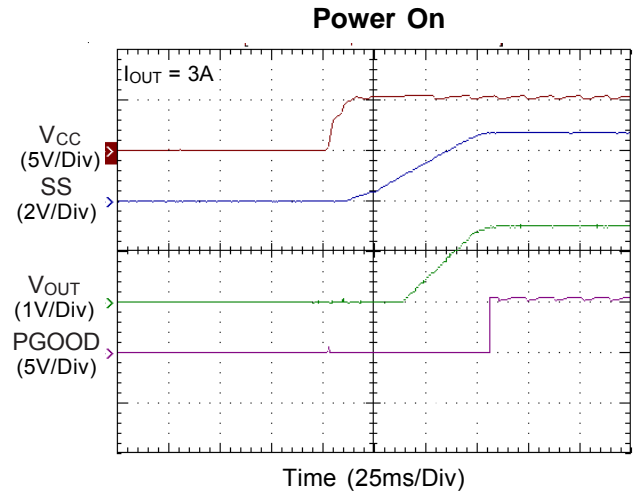
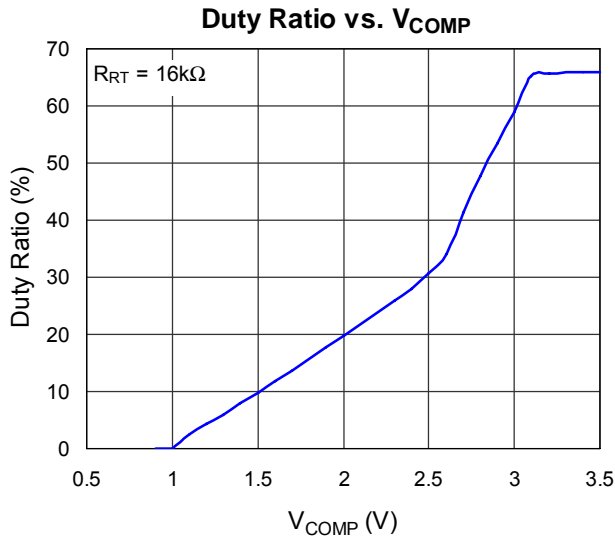
**Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

**Note 2.** Devices are ESD sensitive. Handling precaution recommended.

**Note 3.** The device is not guaranteed to function outside its operating conditions.

**Note 4.** θ<sub>JA</sub> is measured in the natural convection at T<sub>A</sub> = 25°C on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

## Typical Operating Characteristics





## Applications Information

RT9246A is a multi-phase DC/DC controller specifically designed to deliver high quality power for next generation CPU. Phase currents are sensed by innovative time-sharing DCR current sensing technique for channel current balance, droop tuning, and over current protection. Using one common GM amplifier for current sensing eliminates offset errors and linearity variation between GMs. As sub-milli-ohm-grade inductors are widely used in modern mother boards, slight mismatch of GM amplifiers offset and linearity results in considerable current shift between phases. The time-sharing DCR current sensing technique is extremely important to guarantee phase current balance at mass production.

### Converter Initialization, Phase Selection, and Power Good Function

The RT9246A initiates only after two pins are ready: VCC pin power on reset (POR) and DVD pin is higher than 1V. VCC POR is to make sure RT9246A is powered by a voltage for normal work. The rising threshold voltage of VCC POR is 4.2V typically. At VCC POR, RT9246A checks PWM3 status to determine phase number of operation. Pull high PWM3 for two-phase operation. The unused current sense pin should be connected to GND or left floating.

DVD is to make sure that ATX12V is ready for companion MOSFET drivers(RT960X series) to work normally. Connect a voltage divider from ATX12V to DVD pin as shown in the Typical Application Circuit. Make sure that DVD pin voltage is below its threshold voltage before drivers are ready and above its threshold voltage for minimum ATX12V during normal operation.

If either one of VCC and DVD is not ready, RT9246A keeps its PWM outputs high impedance and the companion drivers turn off both upper and lower MOSFETs. After VCC and DVD are ready, RT9246A initiates its soft start cycle as shown in Figure 1. A time-variant internal current source charges the capacitor connected to SS pin. SS voltage ramps up piecewise linearly and locks VID\_DAC output with a specified voltage drop. Consequently, V<sub>CORE</sub> is built up according to VID\_DAC output. PGOOD output is tripped to high impedance when V<sub>CORE</sub> reaches VID\_DAC

output with 1~2ms delay. An SS capacitor about 47nF is recommend for typical application.

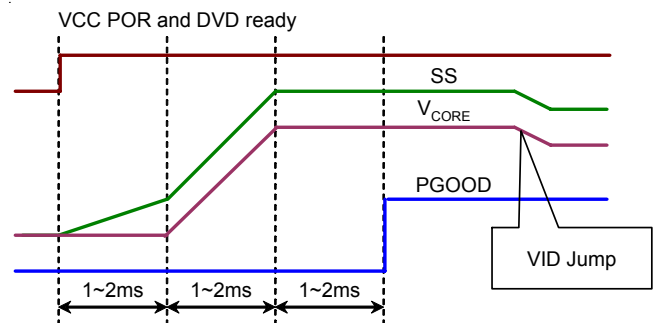


Figure 1. Timing Diagram During Soft Start Interval

### Voltage Control

CPU V<sub>CORE</sub> voltage is Kelvin sensed by FB and FBRTN pins and precisely regulated to VID\_DAC output by internal high gain Error Amplifier (EA). The sensed signal is also used for power good and over voltage function. The typical OVP trip point is 400mV above VID\_DAC output. RT9246A pulls PWM outputs low and latches up upon OVP trip to prevent CPU from damaging. It can only restart by resetting either VCC or DVD pin.

The VID pins are internally pulled high to internal 2.2V with 13kΩ resistors and are easily interfaced with CPU VID outputs. The change of VID\_DAC output at VID Jump is also smoothed by capacitor connected to SS pin. Consequently, V<sub>CORE</sub> shifts to its new position smoothly.

### DCR Current Sensing

RT9246A adopts an innovative time-sharing DCR current sensing technique to sense the phase currents for phase current balance (phase thermal balance) and load line regulation as shown in Figure 2. Current sensing amplifier GM samples and holds voltages V<sub>x</sub> across the current sensing capacitor C<sub>x</sub> by turns in a switching cycle. According to the Basic Circuit Theory, if

$$\frac{L_x}{R_{Lx}} = R_x \times C_x \text{ then } V_x = I_{Lx} \times R_{Lx}$$

Consequently, the sensing current I<sub>x</sub> is proportional to inductor current I<sub>Lx</sub> and is expressed as :

$$I_x = \frac{I_{Lx} \times R_{Lx}}{R_{COMM}}$$

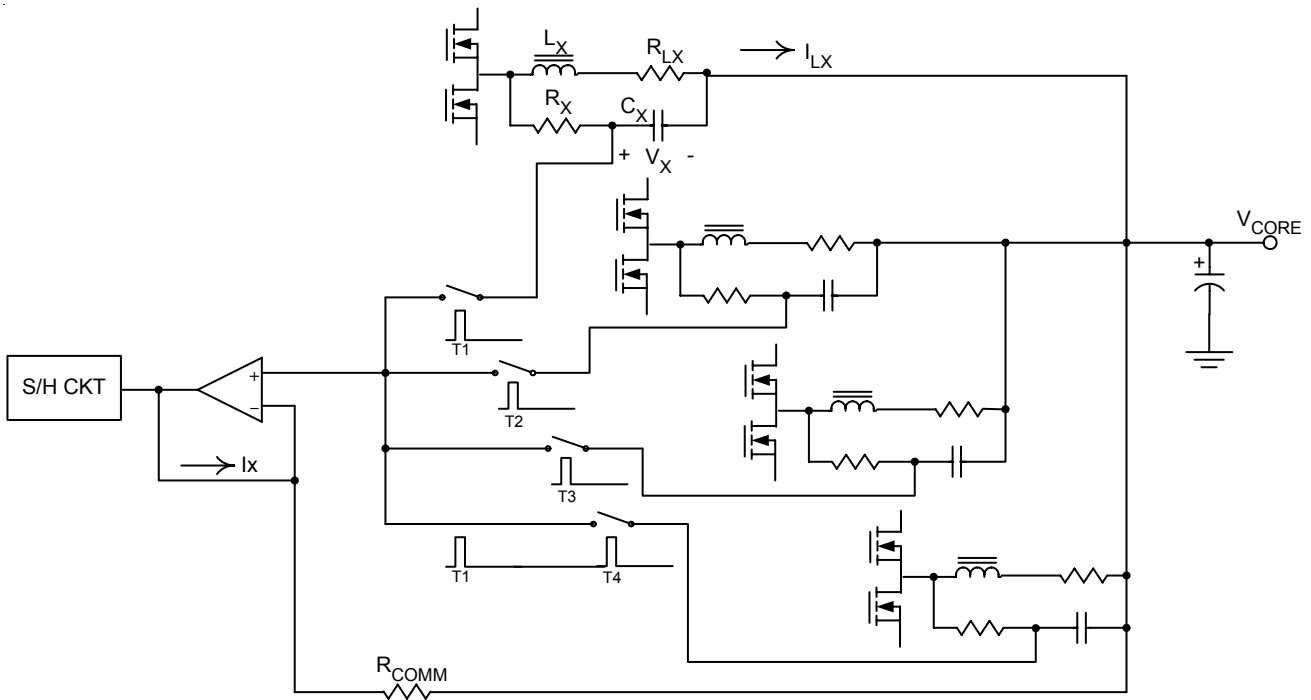


Figure 2

The sensed current  $I_x$  is used for current balance and droop tuning as described as followed. Since all phases share one common GM, GM offset and linearity variation effect is eliminated in practical applications. As sub-milli-ohm-grade inductors are widely used in modern mother boards, slight mismatch of GM amplifiers offset and linearity results in considerable current shift between phases. The time-sharing DCR current sensing technical is extremely important to guarantee phase current balance at mass production.

**Phase Current Balance**

The sampled and held phase current  $I_x$  are summed and averaged to get the averaged current  $\bar{I}_x$ . Each phase current  $I_x$  then is compared with the averaged current. The difference between  $I_x$  and  $\bar{I}_x$  is injected to corresponding PWM comparator. If phase current  $I_x$  is smaller than the averaged current, RT9246A increases the duty cycle of corresponding phase to increase the phase current accordingly, vice versa.

**Over Current Protection**

RT9246A uses an external resistor  $R_{IMAX}$  connected to  $I_{MAX}$  pin to generate a reference current  $I_{IMAX}$  for over current protection:

$$I_{IMAX} = \frac{V_{IMAX}}{R_{IMAX}}$$

where  $V_{IMAX}$  is 1.0V typical. OCP comparator compares each sensed phase current  $I_x$  with this reference current as shown in Figure 3. Equivalently, the maximum phase current is calculated as:

$$I_{LX(MAX)} = \frac{3 V_{IMAX} R_{COMM}}{2 R_{IMAX} R_{LX}}$$

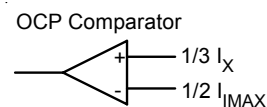


Figure 3. Over Current Comparator

RT9246A uses hiccup mode to eliminate nuisance detection of OCP or reduce output current when output is shorted to ground as shown in Figure 4 and 5.

**Over Current Protection**

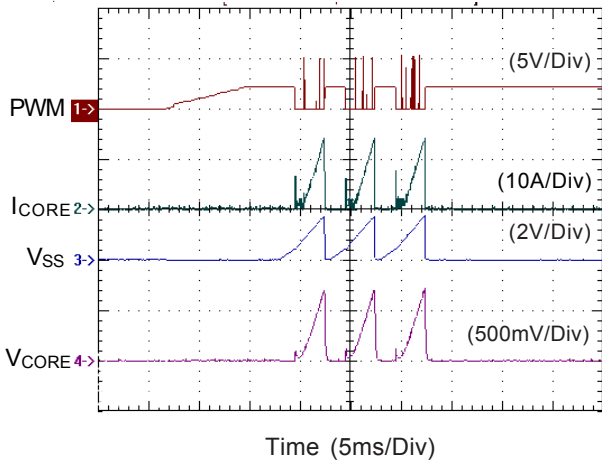


Figure 4. The Over Current Protection in the soft start interval

**Over Current Protection**

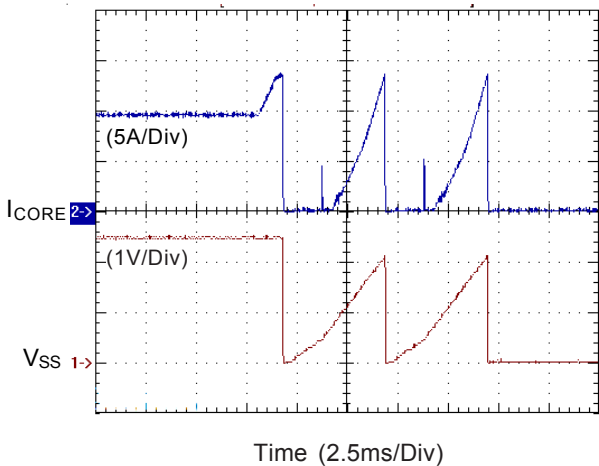


Figure 5. Over Current Protection at steady state

**Droop and Load Line Setting**

RT9246A injects averaged phase current  $\bar{I}_x$  into the resistor  $R_{ADJ}$  connected to ADJ pin to generate a load-current-dependent voltage  $V_{ADJ}$  for droop setting:

$$V_{ADJ} = 8\bar{I}_x R_{ADJ}$$

$V_{ADJ}$  is then subtracted from  $V_{ID\_DAC}$  output as the real reference voltage at non-inverting input of the error amplifier as shown in Figure 6. Consequently, load line slope is calculated as:

$$\text{Load Line} = \frac{\Delta V_{CORE}}{\Delta I_{CORE}} = \frac{8 \times R_{ADJ} \times R_{LX}}{N \times R_{COMM}}$$

where N is the phase number of operation.

The averaged current  $\bar{I}_x$  is also injected into the resistor  $R_{IOUT}$  connected to IOUT pin for monitoring load current. Voltage at IOUT pin  $V_{IOUT}$  is proportional to load current and is calculated as:

$$V_{IOUT} = 8\bar{I}_x \times R_{IOUT} = \frac{8 \times I_{CORE} \times R_{ADJ} \times R_{LX}}{N \times R_{COMM}}$$

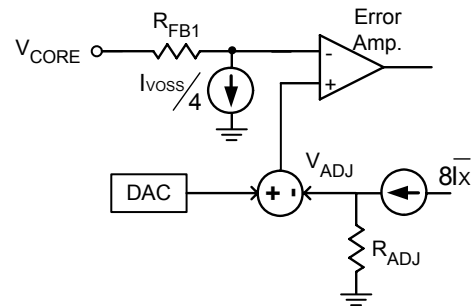


Figure 6. Load Line and Offset Function

**Output Voltage Offset Function**

RT9246A provides programmable initial offset function. External resistor  $R_{VOSS}$  and voltage source at VOSS pin generate offset current  $I_{VOSS} = \frac{V_{VOSS}}{R_{VOSS}}$

, where  $V_{VOSS}$  is 1V typical. One quarter of  $I_{VOSS}$  flows through  $R_{FB1}$  as shown in Figure 6. Error amplifier would hold the inverting pin equal to  $V_{DAC} - V_{ADJ}$ . A constant offset voltage is consequently added to  $V_{DAC} - V_{ADJ}$  as :

$$V_{CORE} = V_{DAC} - V_{ADJ} + \frac{R_{FB1}}{4 \times R_{VOSS}}$$

**Current Ratio Setting**

Current ratio adjustment is possible as described below. It is important for achieving thermal balance in practical application where thermal conditions between phases are not identical. Figure 7 shows the application circuit of GM for current ratio requirement. According to Basic Circuit Theory, if

$$\frac{L_x}{R_{LX}} = (R_{Sx} // R_{Px}) \times C_x \text{ then}$$

$$V_x = \frac{R_{Px}}{R_{Sx} + R_{Px}} \times I_{LX} \times R_{LX}$$

With other phase kept unchanged, this phase would share  $(R_{PX}+R_{SX})/R_{PX}$  times current than other phases. Figure 8 and 9 show different current ratio setting for the power stage when Phase 3 is programmed 2 times current than other phases. Figure 10 and 11 compare the above current ratio setting results.

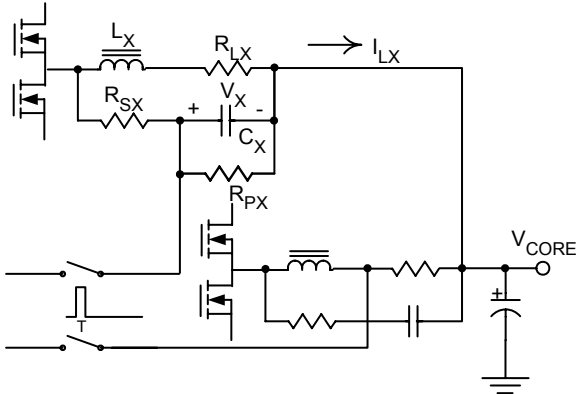


Figure 7

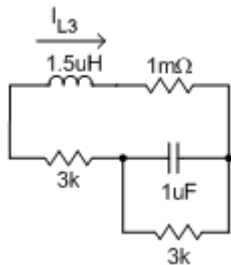


Figure 8. Phase 3 Setting for current ratio function

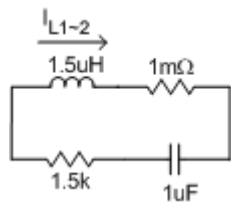


Figure 9. Phase 1~2 Setting for current ratio function

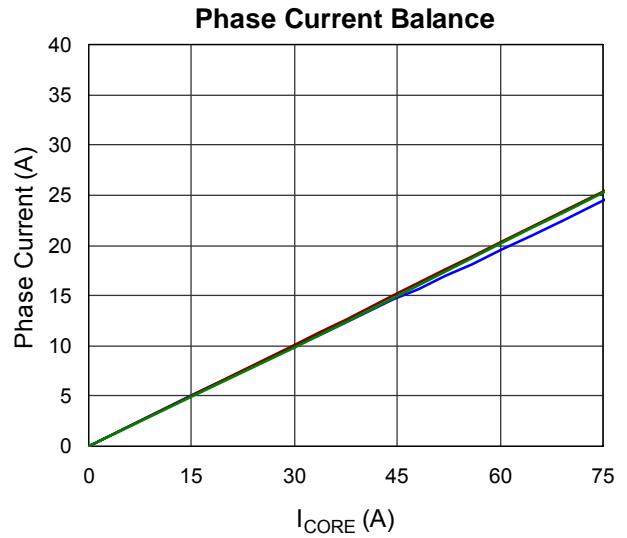


Figure 10

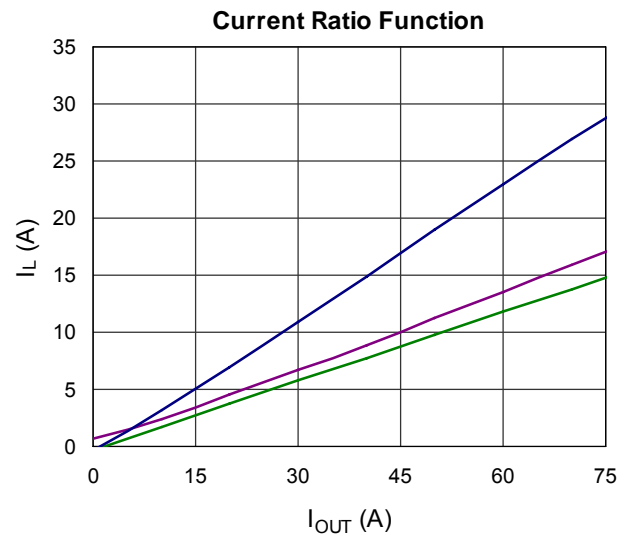


Figure 11

**Dead Zone Elimination**

RT9246A samples and holds inductor valley current by time-sharing sourcing a current  $I_X$  to  $R_{COMM}$ . At light load condition when averaged inductor current is smaller than half of peak-to-peak inductor ripple current, voltage  $V_X$  across the sensing capacitor is negative at valley. It needs a negative  $I_X$  to sense the voltage. However, RT9246A CANNOT provide a negative  $I_X$  and consequently cannot sense negative valley inductor current. This results in dead zone of load line performance as shown in Figure 12. Therefore a technique as shown in Figure 13 is required to eliminate the dead zone of load line at light load condition.

Load Line without dead zone at light loads

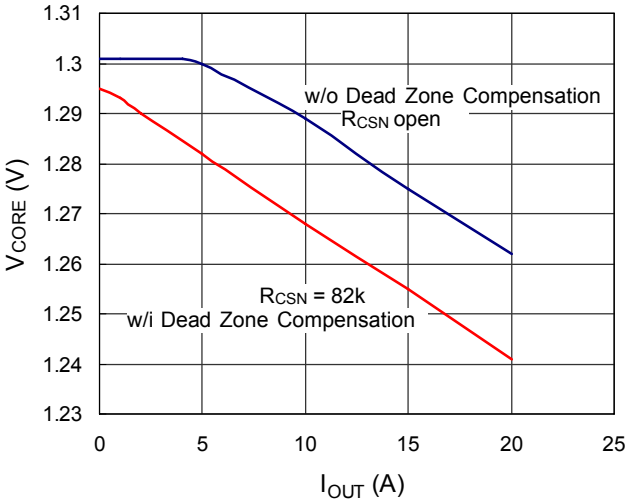


Figure 12

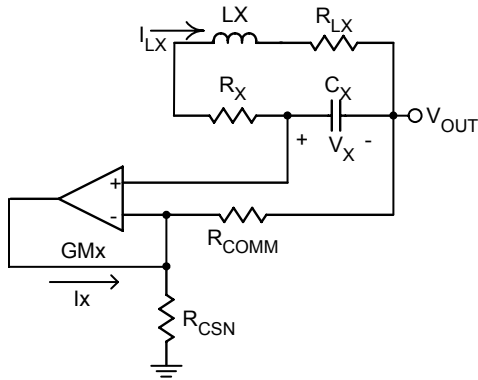


Figure13. Application circuit of GM

Referring to Figure 13, I<sub>x</sub> is expressed as:

$$I_x = \frac{V_{OUT}}{R_{CSN}} + \frac{I_{LX\_V} \times R_{LX}}{R_{CSN}} + \frac{I_{LX\_V} \times R_{LX}}{R_{COMM}} \quad (1)$$

where I<sub>LX\_V</sub> is the valley of inductor current. To make sure RT9246A could sense the valley current, right hand side of Equation (1) should always be positive:

$$\frac{V_{OUT}}{R_{CSN}} + \frac{I_{LX\_V} \times R_{LX}}{R_{CSN}} + \frac{I_{LX\_V} \times R_{LX}}{R_{COMM}} \geq 0 \quad (2)$$

Since R<sub>CSN</sub> >> R<sub>COMM</sub> in practical application, Equation (2) could be simplified as:

$$\frac{V_{OUT}}{R_{CSN}} \geq \left| \frac{I_{LX\_V} \times R_{LX}}{R_{COMM}} \right|$$

For example, assuming the negative inductor valley current is -5A at no load, then for

$$R_{COMM} = 330\Omega, R_{ADJ} = 160\Omega, V_{OUT} = 1.300V$$

$$\frac{1.3V}{R_{CSN}} \geq \left| \frac{-5A \times 1m\Omega}{330\Omega} \right|$$

$$R_{CSN} \leq 85.8k\Omega$$

Choose R<sub>CSN</sub> = 82kΩ

Figure 12 shows that dead zone of load line at light load is eliminated by applying this technique.

**Error Amplifier Characteristic**

For fast response of converter to meet stringent output current transient response, RT9246A provides large slew rate capability and high gain-bandwidth performance.

EA Falling Slew Rate

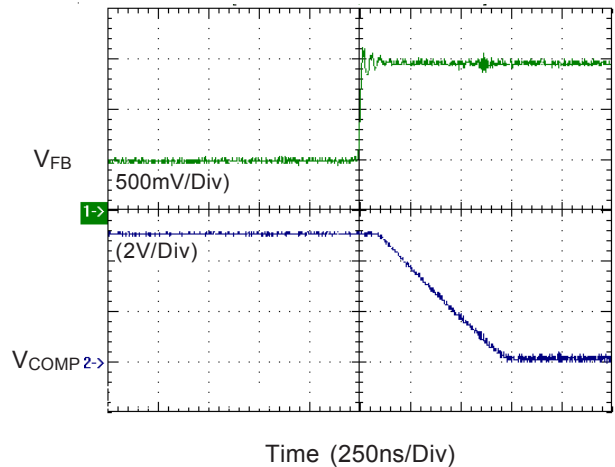


Figure 14. EA Rising Transient with 10pF Loading; Slew Rate=8V/us

EA Rising Slew Rate

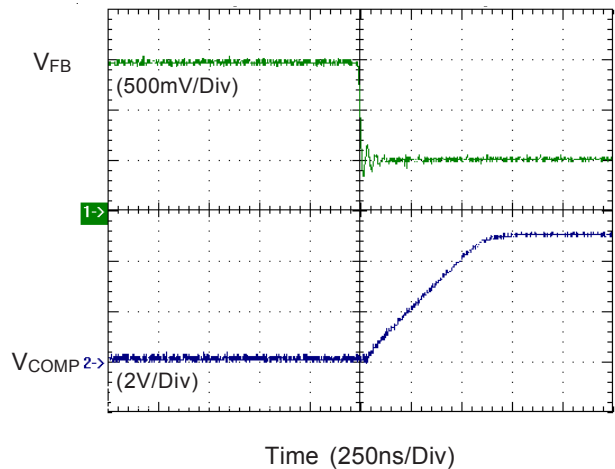


Figure 15. EA Falling Transient with 10pF Loading; Slew Rate=8V/us

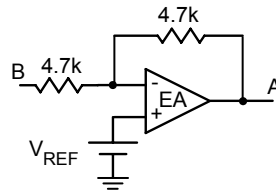


Figure 16. Gain-Bandwidth Measurement by signal A divided by signal B

**Design Procedure Suggestion**

- a. Output filter pole and zero (Inductor, output capacitor value & ESR).
- b. Error amplifier compensation & sawtooth wave amplitude (compensation network).

- DCR = 1mΩ of inductor at 25°C
- L = 1.5μH
- C<sub>OUT</sub> = 8000μF with 5mΩ equivalent ESR.

**Current Loop Setting**

- a. GM amplifier S/H current (current sense component DCR, ISPX and ICOMMON pin external resistor value).
- b. Over-current protection trip point (R<sub>IMAX</sub> resistor).

**1. Compensation Setting**

- a. Modulator Gain, Pole and Zero:

From the following formula:  
 Modulator Gain =  $V_{IN}/V_{RAMP} = 12/1.9 = 6.3$  (i.e 16dB)  
 where  $V_{RAMP}$  : ramp amplitude of saw-tooth wave  
 LC Filter Pole = 1.45kHz and  
 ESR Zero = 3.98kHz

**VRM Load Line Setting**

- a. Droop amplitude (ADJ pin resistor).
- b. No load offset (R<sub>CSN</sub>)
- c. DAC offset voltage setting (VOSS pin and compensation network resistor RB1)

- b. EA Compensation Network:

Select R1 = 4.7k, R2 = 15k, C1 = 12nF, C2 = 68pF and use the Type 2 compensation scheme shown in Figure 17. By calculation, the  $F_Z = 0.88$ kHz,  $F_P = 322$ kHz and Middle Band Gain is 3.19 (i.e 10.07dB).

**Power Sequence & SS**

DVD pin external resistor and SS pin capacitor.

**PCB Layout**

- a. Sense for current sense GM amplifier input.
- b. Refer to layout guide for other items.

**Voltage Loop Setting**

**Design Example**

**Given:**

- Apply for four phase converter
- $V_{IN} = 12V$
- $V_{CORE} = 1.5V$
- $I_{LOAD(MAX)} = 100A$
- $V_{DROOP} = 100mV$  at full load (1mΩ Load Line)
- OCP trip point set at 35A for each channel (S/H)

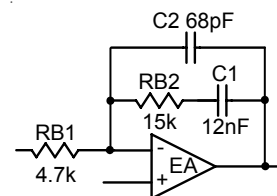


Figure 17. Type 2 compensation network of EA

**Layout Guide**

Place the high-power switching components first, and separate them from sensitive nodes.

1. Most critical path:

The current sense circuit is the most sensitive part of the converter. The current sense resistors tied to ISP1,2,3 and ICOMMON should be located not more than 0.5 inch from the IC and away from the noise switching nodes. The PCB trace of sense nodes should be parallel and as short as possible. R&C filter of choke should place close to PWM and the R & C connect directly to the pin of each output choke, use 10 mil differential pair, and 20 mil gap to other phase pair. Less via as possible.

2. Switching ripple current path:

- a. Input capacitor to high side MOSFET.
- b. Low side MOSFET to output capacitor.
- c. The return path of input and output capacitor.
- d. Separate the power and signal GND.
- e. The switching nodes (the connection node of high/low side MOSFET and inductor) is the most noisy points. Keep them away from sensitive small-signal node.
- f. Reduce parasitic R, L by minimum length, enough copper thickness and avoiding of via.

3. MOSFET driver should be closed to MOSFET.

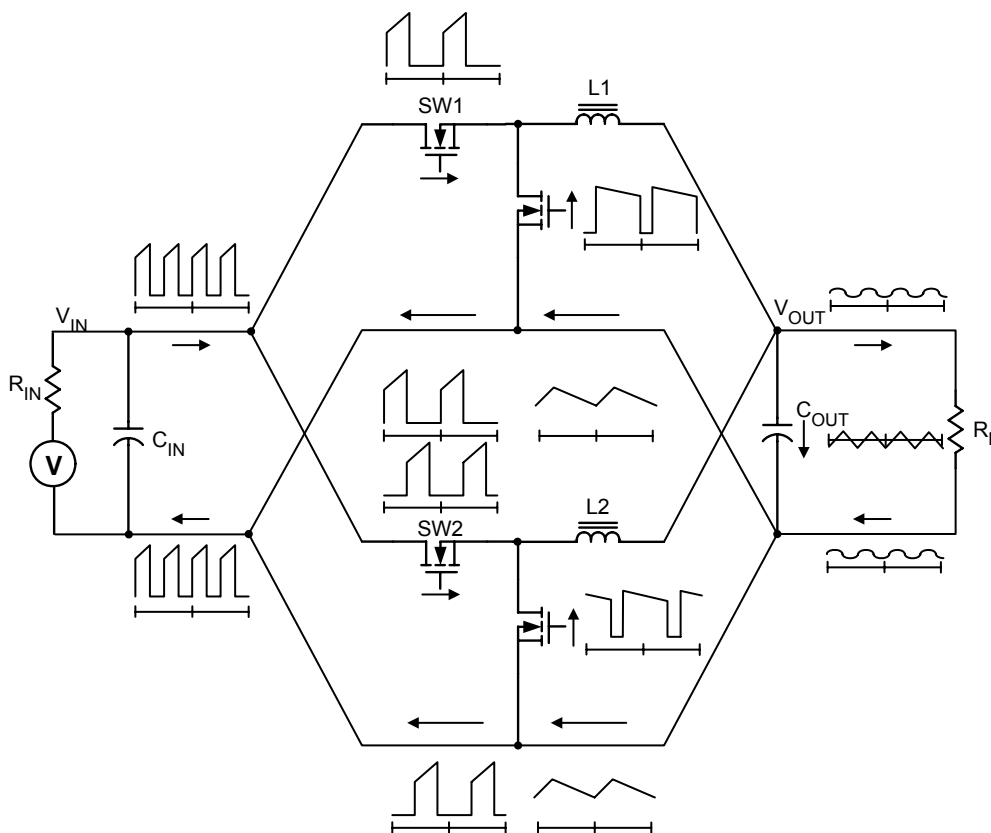
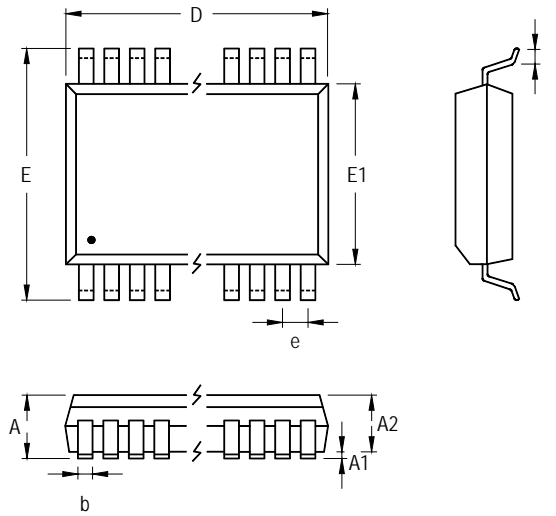


Figure 18. Power Stage Ripple Current Path

Outline Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.850	1.200	0.033	0.047
A1	0.050	0.152	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.178	0.305	0.007	0.012
D	9.601	9.804	0.378	0.386
e	0.650		0.026	
E	6.300	6.500	0.248	0.256
E1	4.293	4.496	0.169	0.177
L	0.450	0.762	0.018	0.030

28-Lead TSSOP Plastic Package

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